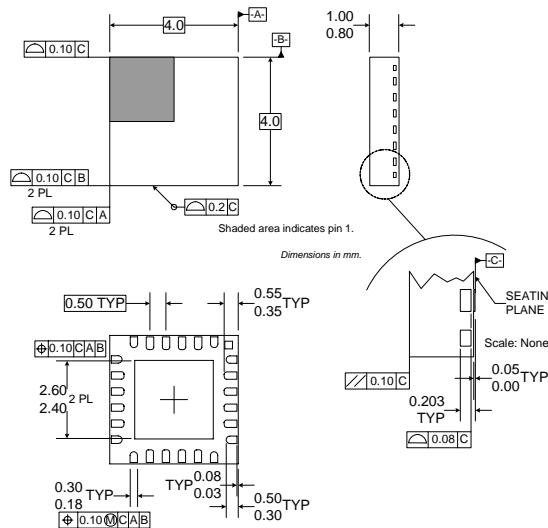


Typical Applications

- 3V W-CDMA Cellular Handset (Band 5)
- 3V W-CDMA US-PCS Handset (Band 2)

Product Description

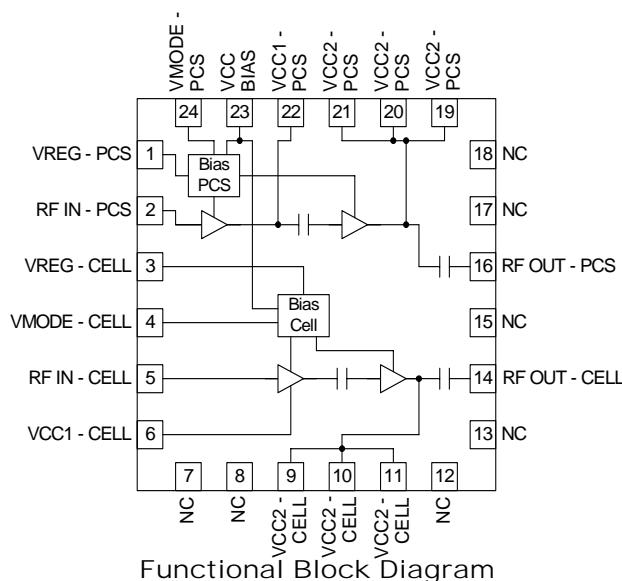
The RF5184 is a high-power, high-efficiency linear amplifier module specifically designed for 3V handheld systems. The device is manufactured on an advanced third generation GaAs HBT process, and was designed for use as the final RF amplifier in W-CDMA handheld digital cellular equipment, spread-spectrum systems, and other applications in the 824MHz to 849MHz band (Band 5) and 1850MHz to 1910MHz band (Band 2). The RF5184 has a digital control line for low power applications to lower quiescent current. The RF5184 is assembled in a 24-pin, 4mmx4mm, QFN package.



Package Style: QFN, 24-Pin, 4x4

Optimum Technology Matching® Applied

- | | | |
|-------------------------------------|--|---------------------------------------|
| <input type="checkbox"/> Si BJT | <input checked="" type="checkbox"/> GaAs HBT | <input type="checkbox"/> GaAs MESFET |
| <input type="checkbox"/> Si Bi-CMOS | <input type="checkbox"/> SiGe HBT | <input type="checkbox"/> Si CMOS |
| <input type="checkbox"/> InGaP/HBT | <input type="checkbox"/> GaN HEMT | <input type="checkbox"/> SiGe Bi-CMOS |



Features

- Input/Output Internally Matched @ 50Ω
- 43% Peak Linear Efficiency for Cell Band
- -41 dBc ACLR @ 5MHz for Cell Band
- -40dBc ACLR @ 5MHz for PCS Band
- 44% Peak Linear Efficiency for PCS Band
- HSDPA Capable

Ordering Information

- RF5184 Dual-Band 800MHz/1900MHz W-CDMA Power Amplifier Module
RF5184PCBA-410 Fully Assembled Evaluation Board

RF Micro Devices, Inc.
7628 Thorndike Road
Greensboro, NC 27409, USA

Tel (336) 664 1233
Fax (336) 664 0454
<http://www.rfmd.com>

RF5184

Absolute Maximum Ratings

Parameter	Rating	Unit
Supply Voltage (RF off)	+8.0	V
Supply Voltage ($P_{OUT} \leq 31 \text{ dBm}$)	+5.2	V
Control Voltage (V_{REG})	+3.9	V
Input RF Power	+10	dBm
Mode Voltage (V_{MODE})	+3.9	V
Operating Temperature	-30 to +110	°C
Storage Temperature	-40 to +150	°C



Caution! ESD sensitive device.

RF Micro Devices believes the furnished information is correct and accurate at the time of this printing. However, RF Micro Devices reserves the right to make changes to its products without notice. RF Micro Devices does not assume responsibility for the use of the described product(s).

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
High Power Mode - W-CDMA Cell Band (V_{MODE} Low)					$T=25^{\circ}\text{C}$ Ambient, $V_{CC}=3.4\text{V}$, $V_{REG}=2.8\text{V}$, $V_{MODE}=0\text{V}$, and $P_{OUT}=28\text{dBm}$ for all parameters (unless otherwise specified).
Operating Frequency Range	824			MHz	
Linear Gain	26.0	28.5	31.0	dB	
Maximum Linear Output	28			dBm	
Linear Efficiency	39	43		%	
Maximum I_{CC}		432	476	mA	
ACLR @ 5MHz	-37	-41		dBc	
ACLR @ 10MHz	-48	-54		dBc	
Input VSWR		2:1			No oscillation > -70dBc
Stability In-Band			6:1		No damage
Stability Out-of-Band			10:1		At 45MHz offset.
Noise Power		-133		dBm/Hz	
Mid Power Mode - W-CDMA Cell Band (V_{MODE} High)					$T=25^{\circ}\text{C}$ Ambient, $V_{CC}=3.4\text{V}$, $V_{REG}=2.8\text{V}$, $V_{MODE}=2.8\text{V}$, and $P_{OUT}=16\text{dBm}$ for all parameters (unless otherwise specified).
Operating Frequency Range	824			MHz	
Linear Gain	25	27	30	dB	
Maximum Linear Output	16			dBm	
Maximum I_{CC}		125	150	mA	
ACLR @ 5MHz	-37	-41		dBc	
ACLR @ 10MHz	-48	-59		dBc	
Input VSWR		2:1			No oscillation > -70dBc
Output VSWR Stability			6:1		No damage
			10:1		
Low Power Mode - W-CDMA Cell Band (V_{MODE} High)					$T=25^{\circ}\text{C}$ Ambient, $V_{CC}=0.75\text{V}$, $V_{REG}=2.8\text{V}$, $V_{MODE}=2.8\text{V}$, and $P_{OUT}=8\text{dBm}$ for all parameters (unless otherwise specified).
Operating Frequency Range	824			MHz	
Linear Gain		22		dB	
Efficiency		11.5		%	
ACLR @ 5MHz		-42		dBc	
ACLR @ 10MHz		-55		dBc	

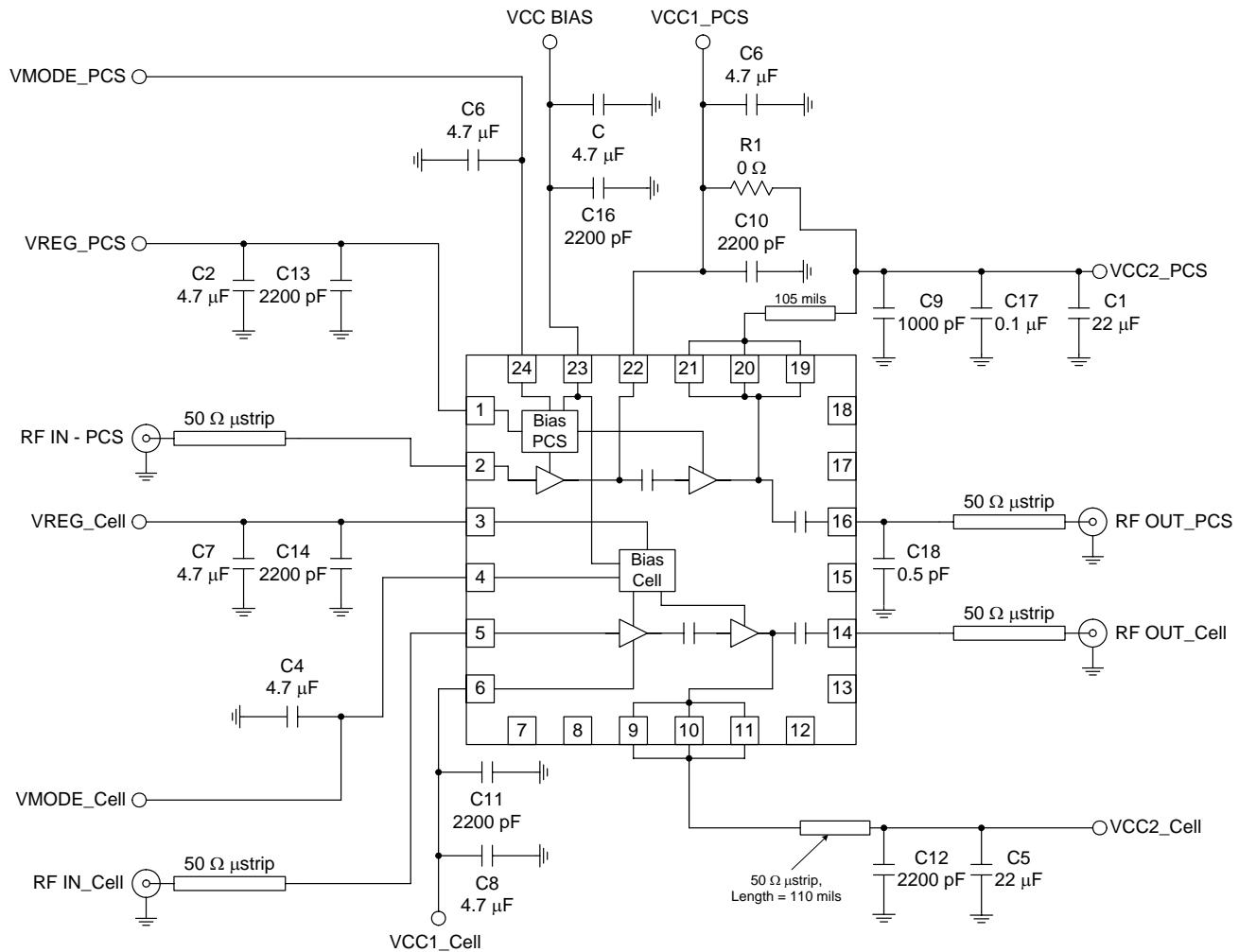
Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
High Power Mode - W-CDMA PCS Band (V_{MODE} Low)					$T=25^{\circ}\text{C}$ Ambient, $V_{CC}=3.4\text{V}$, $V_{REG}=2.8\text{V}$, $V_{MODE}=0\text{V}$, and $P_{OUT}=28\text{dBm}$ for all parameters (unless otherwise specified).
Operating Frequency Range	1850		1910	MHz	
Linear Gain	26.5	29.0	31.5	dB	
Maximum Linear Output	28			dBm	
Linear Efficiency	39	44		%	
Maximum I_{CC}		422	476	mA	
ACLR @ 5MHz	-36	-40		dBc	
ACLR @ 10MHz	-47	-51		dBc	
Input VSWR		2:1			No oscillation > -70 dBc
Output VSWR Stability			6:1		No damage
Noise Power		-137	10:1	dBm/Hz	At 80MHz offset.
Mid Power Mode - W-CDMA PCS Band (V_{MODE} High)					$T=25^{\circ}\text{C}$ Ambient, $V_{CC}=3.4\text{V}$, $V_{REG}=2.8\text{V}$, $V_{MODE}=2.8\text{V}$, and $P_{OUT}=16\text{dBm}$ for all parameters (unless otherwise specified).
Operating Frequency Range	1850		1910	MHz	
Linear Gain	25.5	28.0	30.5	dB	
Maximum Linear Output	16			dBm	
ACLR @ 5MHz	-36	-42		dBc	
ACLR @ 10MHz	-47	-58		dBc	
Maximum I_{CC}		125	150	mA	
Input VSWR		2:1			No oscillation > -70 dBc
Output VSWR Stability			6:1		No damage
Low Gain Mode - W-CDMA PCS Band (V_{MODE} High)					$T=25^{\circ}\text{C}$ Ambient, $V_{CC}=0.75\text{V}$, $V_{REG}=2.8\text{V}$, $V_{MODE}=2.8\text{V}$, and $P_{OUT}=8\text{dBm}$ for all parameters (unless otherwise specified).
Operating Frequency Range	1850		1910	MHz	
Linear Gain		22		dB	
ACLR @ 5MHz		-43		dBc	
ACLR @ 10MHz		-58		dBc	
Efficiency		11.5		%	

RF5184

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Power Supply					
Supply Voltage	3.2	3.4	4.2	V	
High Power Idle Current - Cell	45	60	80	mA	
Mid Power Idle Current - Cell	35	45	70	mA	
Low Power Idle Current - Cell		42		mA	
V_{REG} Current - Cell		2.5	4.0	mA	
High Power Idle Current - PCS	45	70	95	mA	
Mid Power Idle Current - PCS	40	60	85	mA	
Low Power Idle Current - PCS		57		mA	
V_{REG} Current - PCS		2	4	mA	
V_{MODE} Current		125	350	uA	
RF Turn On/Off Time		1.2	6	uS	
DC Turn On/Off Time		2	40	uS	
Total Current (Power Down)		0.2	2.0	uA	
V_{REG} Low Voltage (Power Down)	0		0.5	V	
V_{REG} High Voltage (Recommended)	2.75	2.8	2.95	V	
V_{REG} High Voltage (Operational)	2.7		3.0	V	
V_{MODE} Voltage	0		0.5	V	High Gain Mode
V_{MODE} Voltage	2.0		3.0	V	Low Gain Mode

Pin	Function	Description	Interface Schematic
1	VREG_PCS	Regulated voltage supply for PCS band amplifier bias circuit. In power down mode, both V _{REG_PCS} and V _{MODE_PCS} need to be LOW (<0.5V).	
2	RFIN_PCS	PCS band RF input internally matched to 50Ω. This input is internally AC-coupled.	
3	VREG_Cell	Regulated voltage supply for Cell band amplifier bias circuit. In power down mode, both V _{REG_Cell} and V _{MODE_Cell} need to be LOW (<0.5V).	
4	VMODE_Cell	Cell band mode control pin. For nominal operation (High Power mode), V _{MODE_Cell} is set LOW. When set HIGH, devices are biased lower to improve efficiency.	
5	RFIN_Cell	Cell band RF input internally matched to 50Ω. This input is internally AC-coupled.	
6	VCC1_Cell	Cell band first stage collector supply. A 2200uF and a 4.7μF decoupling capacitors are required.	
7	NC	No connection. Do not connect this pin to any external circuit.	
8	NC	No connection. Do not connect this pin to any external circuit.	
9	VCC2_Cell	Cell band output stage collector supply. Please see the schematic for required external components.	
10	VCC2_Cell	Same as Pin 9.	
11	VCC2_Cell	Same as Pin 9.	
12	NC	No connection. Do not connect this pin to any external circuit.	
13	NC	No connection. Do not connect this pin to any external circuit.	
14	RFOUT_Cell	Cell band RF output. Internally AC-coupled.	
15	NC	No connection. Do not connect this pin to any external circuit.	
16	RFOUT_PCS	PCS band RF output. Internally AC-coupled.	
17	NC	No connection. Do not connect this pin to any external circuit.	
18	NC	No connection. Do not connect this pin to any external circuit.	
19	VCC2_PCS	PCS band output stage collector supply. Please see the schematic for required external components.	
20	VCC2_PCS	Same as Pin 19.	
21	VCC2_PCS	Same as Pin 19.	
22	VCC1_PCS	PCS band first stage collector supply. A 4.7μF decoupling capacitor is required.	
23	VCC BIAS	Bias circuit supply voltage.	
24	VMODE_PCS	PCS band mode control pin. For nominal operation (High Power mode), V _{MODE_PCS} is set Low. When set HIGH, devices are biased lower to improve efficiency.	
Pkg Base	GND	The backside of the package should be soldered to a top side ground pad which is connected to the ground plane with multiple vias. The pad should have a short thermal path to the ground plane.	

Evaluation Board Schematic - W-CDMA



PCB Design Requirements

PCB Surface Finish

The PCB surface finish used for RFMD's qualification process is electroless nickel, immersion gold. Typical thickness is 3 μ inch to 8 μ inch gold over 180 μ inch nickel.

PCB Land Pattern Recommendation

PCB land patterns are based on IPC-SM-782 standards when possible. The pad pattern shown has been developed and tested for optimized assembly at RFMD; however, it may require some modifications to address company specific assembly processes. The PCB land pattern has been developed to accommodate lead and package tolerances.

PCB Metal Land Pattern

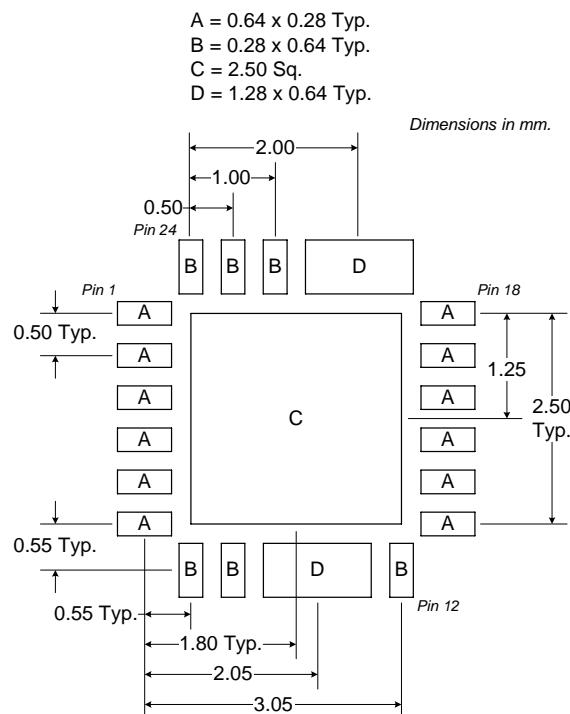


Figure 1. PCB Metal Land Pattern (Top View)

RF5184

PCB Solder Mask Pattern

Liquid Photo-Imageable (LPI) solder mask is recommended. The solder mask footprint will match what is shown for the PCB metal land pattern with a 2mil to 3mil expansion to accommodate solder mask registration clearance around all pads. The center-grounding pad shall also have a solder mask clearance. Expansion of the pads to create solder mask clearance can be provided in the master data or requested from the PCB fabrication supplier.

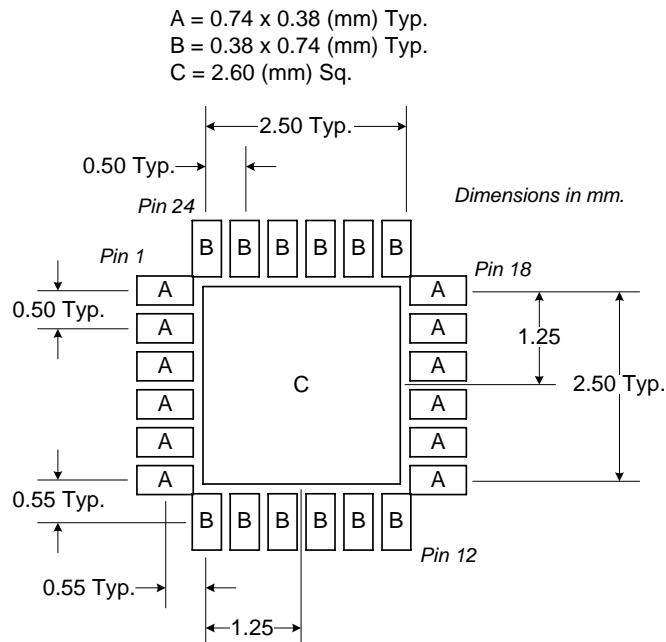


Figure 2. PCB Solder Mask (Top View)